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### (54) Title: THERMAL TREATMENT PROCESS OF POSITIVE PHOTORESIST COMPOSITION

#### (57) Abstract

A flash softbake process for a diazonaphthoquinone sulfonate ester-novolak positive photoresist is described which offers significant advantages. This process uses a higher than conventional soft-baking (SB) temperature (≥130 °C) and a very short baking time (≤ 30 seconds) of the resist, preferably over a bottom antireflective coating. It significantly improves the photoresist's resolution, process latitude, thermal deformation temperature, resist adhesion and plasma etch resistance. If a low reflectivity substrate or an antireflective coating is used, it also eliminates the need for a post exposure bake (PEB) step during the photolithographic process, without causing a severe standing wave effect.

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## INTERNATIONAL SEARCH REPORT

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